



Product Summary

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C	
30	2.0	0.42	1.0	

Description and Applications

This MBR230S1F is a single rectifier packaged in SOD123F. Ideally suited for low voltage, high frequency rectification or as freewheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "O-ring" of multiple supply voltages and any other application where performance and size are critical.

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features and Benefits

- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improving Efficiency
- Guard Ring Die Construction for Transient Protection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.0016 grams (approximate)

SOD123F



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
MBR230S1F-7	SOD123F	3000/Tape & Reel

1, EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

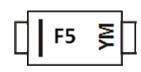
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information

Notes:



F5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex.: B = 2014) M = Month (ex: 9 = September)

Date Code	e Key											
Year		2014	2015	20	016	2017	201	8	2019	2020)	2021
Code		В	С		D	E	F		G	Н		I
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Rectified Output Current	lo	2.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5) Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJC} R _{θJA}	50 120	°C/W
Total Power Dissipation (Note 5)	P _{TOT}	0.84	W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

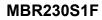
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

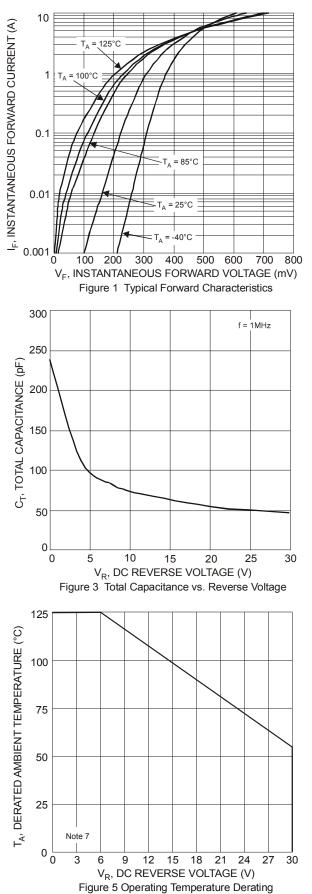
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _(BR)	30	—	—	V	I _R = 1.0 mA
Forward Voltage Drop	VF	_	0.31 0.37 0.32	 0.42 	V	$I_F = 1A, T_A = +25^{\circ}C$ $I_F = 2A, T_A = +25^{\circ}C$ $I_F = 2A, T_A = +100^{\circ}C$
Leakage Current (Note 6)	I _R	_	0.3 30	1.0	mA	VR = 30V, TA = +25°C VR = 30V, TA = +100°C
Total Capacitance	Ст	—	75	—	pF	VR = 10V, f = 1.0MHz

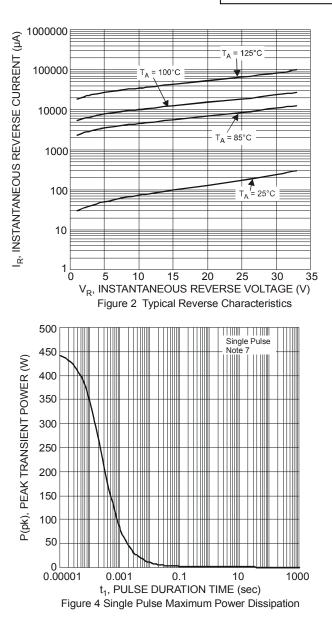
Notes:

Device mounted on FR-4 substrate, 1" x 1", 2 oz, single-sided, PC boards with 0.1"*0.15" copper pad.
Short duration pulse test used to minimize self-heating effect.
Device mounted on FR-4 substrate, 1" x 1", 2 oz, single-sided, PC boards with minimum recommended pad per http://www.diodes.com/datasheets/ap02001.

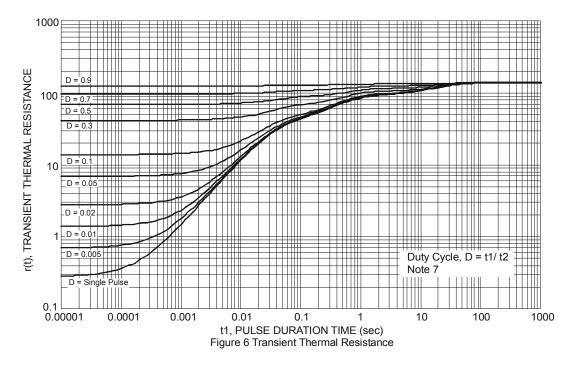






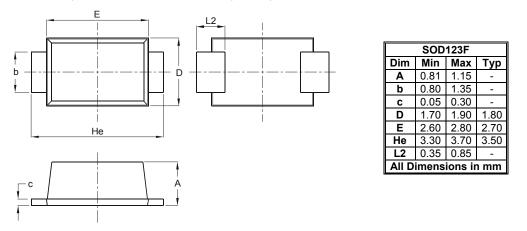






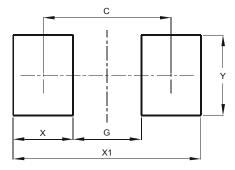
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
С	2.86
G	1.52
Х	1.34
X1	4.20
Y	1.80



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